# 150KHz, 2A PWM Buck DC/DC Converter

#### ✤ GENERAL DESCRIPTION

The AX2596S series are monolithic IC designed for a step-down DC/DC converter, and own the ability of driving a 2A load without additional transistor. It saves board space. The external shutdown function can be controlled by logic level and then come into standby mode. The internal compensation makes feedback control having good line and load regulation without external design. Regarding protected function, thermal shutdown is to prevent over temperature operating from damage, and current limit is against over current operating of the output switch. If current limit function occurs and  $V_{FB}$  is down below 0.5V, the switching frequency will be reduced.

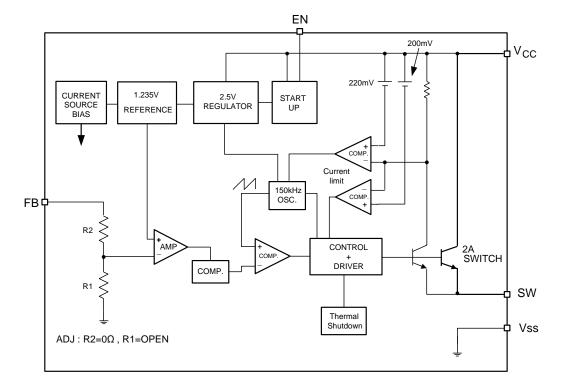
The AX2596S series operates at a switching frequency of 150KHz thus allow smaller sized filter components than what would be needed with lower frequency switching regulators. The output version included fixed 3.3V, 5V, and an adjustable type. The chips are available in standard 8-lead SOP, SOP-8L with Exposed pad packages.

#### ✤ FEATURES

- Output voltage: 3.3V, 5V and adjustable output version1.
- Adjustable version output voltage range, 1.23V to 38.5V.
- 150KHz fixed switching frequency.
- Voltage mode non-synchronous PWM control.
- Thermal-shutdown and current-limit protection.
- ON/OFF shutdown control input.
- Short Circuit Protect (SCP).
- Operating voltage can be up to 40V.
- Output load current: 2A.
- SOP-8L, SOP-8L-EP Pb-Free packages.
- Low power standby mode.
- Built-in switching transistor on chip.
- RoHS and Halogen free compliance.

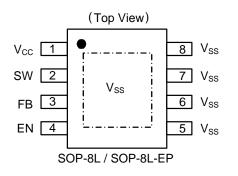
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✤ BLOCK DIAGRAM



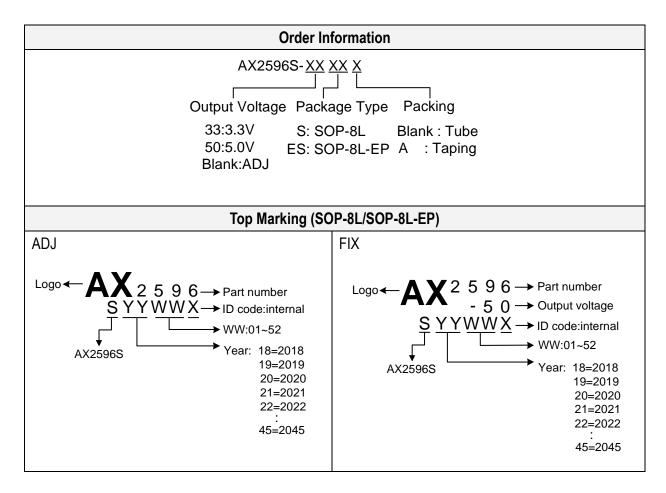
### PIN ASSIGNMENT

The packages of AX2596S are SOP-8L, SOP-8L-EP; the pin assignment is given by:



Name	Description
Vcc	Operating voltage input
SW	Switching output
FB	Output voltage feedback control
EN	ON/OFF Shutdown
Vss	GND pin

### ✤ ORDER/MARKING INFORMATION



#### ✤ ABSOLUTE MAXIMUM RATINGS

Characteristics	Symbol	Rating	Unit
Maximum Supply Voltage	Vcc	+45	V
ON/OFF Pin Input Voltage	$V_{\text{EN}}$	-0.3 to 40	V
Feedback Pin Voltage	$V_{FB}$	-0.3 to 12	V
Output Voltage to Ground	V <sub>OUT</sub>	-0.8	V
Power Dissipation Internally limited	PD	( T <sub>J</sub> -T <sub>A</sub> ) / θ <sub>JA</sub>	W
Storage Temperature Range	T <sub>ST</sub>	-65 to +150	°C
Operating Junction Temperature Range	TJ	-40 to +125	°C
Operating Supply Voltage	V <sub>OP</sub>	+4.5 to +40	V
Thermal Resistance from Junction to case	0	SOP-8L=20	°C/M
	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	°C/W	
	<u>^</u>	SOP-8L=60	
Thermal Resistance from Junction to ambient	θ <sub>JA</sub>	SOP-8L-EP=40	°C/W

Note:  $\theta_{JA}$  is measured with the PCB copper area(need connect to V<sub>SS</sub> pins) of approximately 1.5 in<sup>2</sup> (Multi-layer).

# ✤ ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, T<sub>A</sub>=25°C, V<sub>CC</sub>=12V for 3.3V, 5V, adjustable version.  $I_{LOAD} = 0.2A$ )

Ch	aracteristics	Symbol	Conditions	Min	Тур	Max	Units
Quiescent Cur	rrent	lq	V <sub>FB</sub> =12V force driver off		4	8	mA
Feedback bias current		I <sub>FB</sub>	V <sub>FB</sub> =1.3V (Adjustable version only)		-10	-500	nA
Shutdown sup	pply Current	Isd	EN pin=5V V <sub>CC</sub> =40V		100	200	uA
Oscillator freq	uency	Fosc		127	150	173	KHz
	quency of short circuit	F <sub>SCP</sub>	(Adjustable) When V <sub>FB</sub> <0.5V		50		KHz
protect		1 30P	(Fixed)When < V <sub>o∪⊺</sub> *40%		50		KHz
Max. Duty Cyc	cle (ON)	DC	V <sub>FB</sub> =0V force driver on		100		%
Min. Duty Cyc	le (OFF)	DC	V <sub>FB</sub> =12V force driver off	0			/0
Current limit		ICL	Pear current, No outside circuit V <sub>FB</sub> =0V force driver on	2.5			А
Load Regulati	on(	$\Delta V_{OUT}$	I <sub>OUT</sub> = 0.2 to 2A	-	0.6	1.2	%
Saturation vol	tage	V <sub>SAT</sub>	I <sub>OUT</sub> =2A, No outside circuit V <sub>FB</sub> =0V force driver on		1.2	1.4	V
SW pin=0V	SW pin leakage	I <sub>SWL</sub>	No outside circuit V <sub>FB</sub> =12V force driver off			-200	uA
SW pin=-0.8V	current	0112	V <sub>CC</sub> =40V force driver off		-5		mA
EN pin logic input threshold voltage		VIL	Low (regulator ON)	-	1.3	0.6	V
		VIH	High (regulator OFF)	2.0		-	
EN pin logic input current		Iн	V <sub>EN</sub> =2.5V (OFF)		-0.1	-10	uA
EN pin input current		١L	V <sub>EN</sub> =0.5V (ON)		-0.01	-1.5	uΑ
Thermal shutd	lown Temp	T <sub>SD</sub>			135		°C

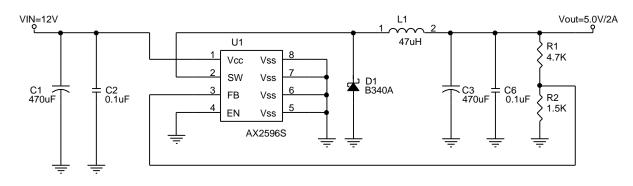
#### ✤ ELECTRICAL CHARACTERISTICS (CONTINUED)

Version	Characteristics	Symbol	Conditions	Min	Тур	Max	Units
AX2596S-ADJ	Output Feedback voltage	V <sub>FB</sub>	I <sub>LOAD</sub> =0.2A V <sub>OUT</sub> programmed for 3.3V	1.193	1.23	1.267	V
	Efficiency	η	V <sub>CC</sub> = 12V, I <sub>LOAD</sub> =2A		79		%
AV25060 2 2V	Output voltage	V <sub>OUT</sub>	I <sub>LOAD</sub> =0.2A	3.20	3.30	3.40	V
AX2596S-3.3V	Efficiency	η	V <sub>CC</sub> = 12V, I <sub>LOAD</sub> =2A		80		%
	Output voltage	V <sub>OUT</sub>	I <sub>LOAD</sub> =0.2A	4.85	5.00	5.15	V
AX2596S-5.0V	Efficiency	η	V <sub>CC</sub> = 12V, I <sub>LOAD</sub> =2A		84		%

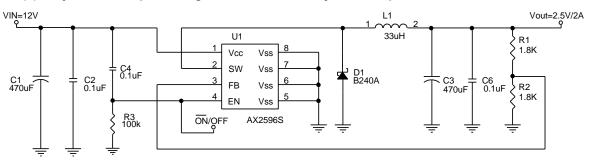
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### ✤ APPLICATION CIRCUIT

(1) Adjustable Output Voltage Version



(2) Adjustable Output Voltage Version With Delayed Startup



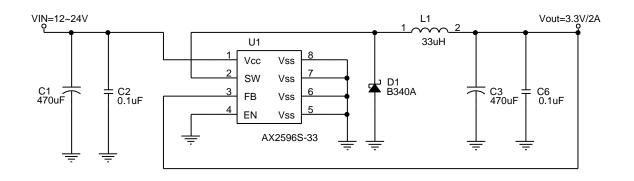
$$V_{OUT} = V_{FB} \times (1 + \frac{R1}{R2}), V_{FB} = 1.23V, R2 = 0.47K \sim 3K$$

Table 1 Resistor	select for output	it voltage setting
Vout	R2	R1

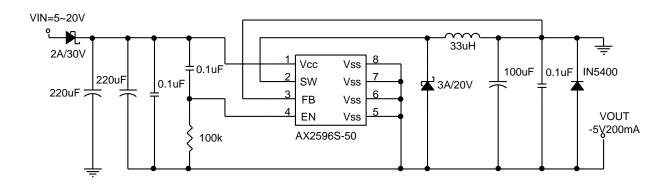
V <sub>OUT</sub>	R2	R1
5V	1.5K	4.7K
50	1.8K	5.6K
3.3V	1.5K	2.5K
5.5V	1.8K	3.0K
2.5V	1.8K	1.8K
1.8V	1.8K	0.82K

L1 recommend value (I <sub>OUT</sub> =2A,)					
V <sub>OUT</sub>	2.5V 3.3V 5V				
V <sub>IN</sub> =12V	33uH	33uH	47uH		
V <sub>IN</sub> =24V	33uH	33uH	47uH		

(3) Fixed Output Voltage Version



### (4) Inverting -5V Regulator with Delayed Startup



### ✤ FUNCTION DESCRIPTION

#### **Pin Functions**

Vcc

This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be presented at this pin to minimize voltage transients and to supply the switching currents needed by the regulator.

Vss

Circuit ground.

#### SW

Internal switch. The voltage at this pin switches between  $(+V_{CC} - V_{SAT})$  and approximately – 0.5V, with a duty cycle of approximately  $V_{OUT}$  /  $V_{CC}$ . To minimize coupling to sensitive circuitry, the PC board copper area connected to this pin should be minimized.

#### Feedback

Senses the regulated output voltage to complete the feedback loop.

### EN

Allows the switching regulator circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately 100uA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of  $V_{CC}$ ) shuts the regulator down. If this shutdown feature is not needed, the EN pin can be wired to the ground pin.

#### **Thermal Considerations**

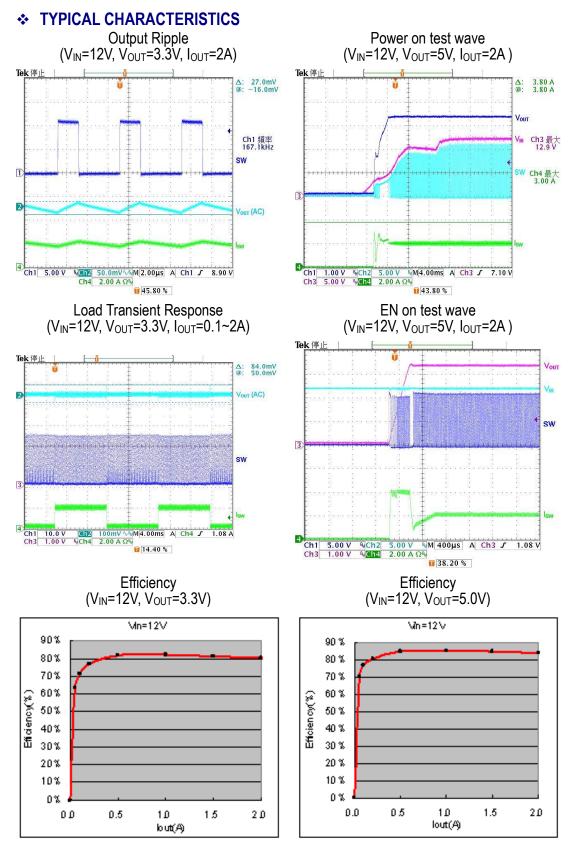
The SOP-8L package needs a heat sink under most conditions. The size of the heat sink depends on the input voltage, the output voltage, the load current and the ambient temperature. The AX2596S junction temperature rises above ambient temperature for a 2A load and different input and output voltages.

The data for these curves was taken with the AX2596S (SOP-8L package) operating as a buck-switching regulator in an ambient temperature of 25°C (still air). These temperature increments are all approximate and are affected by many factors. Higher ambient temperatures require more heat sinker.

For the best thermal performance, wide copper traces and generous amounts of printed circuit board copper (need connect to the  $V_{SS}$  pins) should be used in the board layout, (One exception is the SW(switch) pin, which should not have large areas of copper.) Large areas of copper provide the best transfer of heat (lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

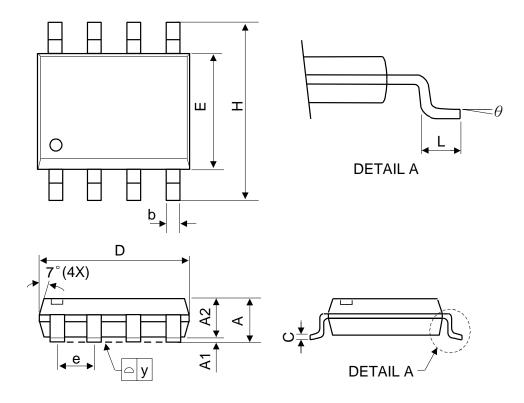
Package thermal resistance and junction temperature increments are all approximate. The increments are affected by a lot of factors. Some of these factors include board size, shape, thickness, position, location, and even board temperature. Other factors are, trace width, total printed circuit copper area, copper thickness, single or double-sided, multi-layer board and the amount of solder on the board.

The effectiveness of the PC board to dissipate heat also depends on the size, quantity and spacing of other components on the board, as well as whether the surrounding air is still or moving. Furthermore, some of these components such as the catch diode will add heat to the PC board and the heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.



# ✤ PACKAGE OUTLINES

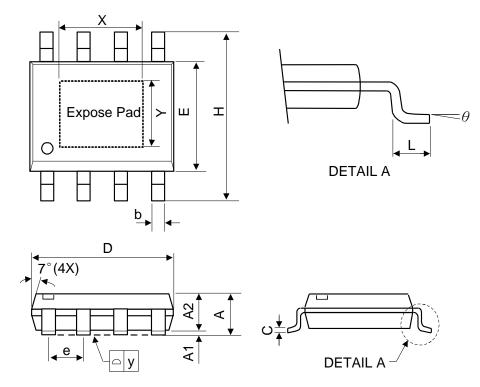
(1) SOP-8L



Symbol	Dime	Dimensions in Millimeters			Dimensions in Inches		
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max.	
A	-	-	1.75	-	-	0.069	
A1	0.1	-	0.25	0.04	-	0.1	
A2	1.25	-	-	0.049	-	-	
С	0.1	0.2	0.25	0.0075	0.008	0.01	
D	4.7	4.9	5.1	0.185	0.193	0.2	
E	3.7	3.9	4.1	0.146	0.154	0.161	
Н	5.8	6	6.2	0.228	0.236	0.244	
L	0.4	-	1.27	0.015	-	0.05	
b	0.31	0.41	0.51	0.012	0.016	0.02	
е		1.27 BSC			).050 BSC		
у	-	-	0.1	-	-	0.004	
$\theta$	00	-	<b>8</b> 0	<b>0</b> 0	-	<b>8</b> 0	

Mold flash shall not exceed 0.25mm per side JEDEC outline: MS-012 AA

(2) SOP-8L-EP

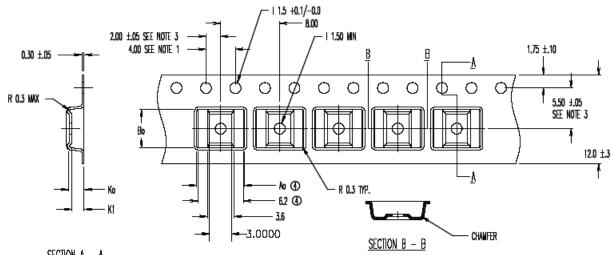


Symbol	Dim	ensions in M	illimeters	Dimensions in Inches		
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max.
Α	-	-	1.75	-	-	0.069
A1	0	-	0.15	0	-	0.06
A2	1.25	-	-	0.049	-	-
С	0.1	0.2	0.25	0.0075	0.008	0.01
D	4.7	4.9	5.1	0.185	0.193	0.2
E	3.7	3.9	4.1	0.146	0.154	0.161
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L	0.4	-	1.27	0.015	-	0.05
b	0.31	0.41	0.51	0.012	0.016	0.02
е		1.27 BSC			0.050 BSC	
у	-	-	0.1	-	-	0.004
Х	-	2.34	_	-	0.092	-
Y	-	2.34	-	-	0.092	-
θ	00	-	<b>8</b> 0	00	-	<b>8</b> 0

Mold flash shall not exceed 0.25mm per side JEDEC outline: MS-012 BA

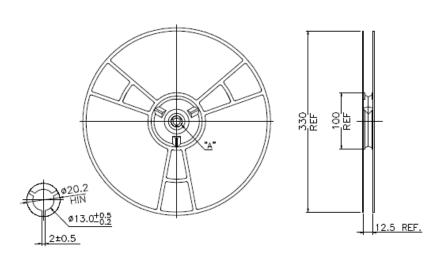
# ✤ CARRIER TAPE DIMENSION

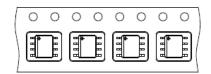
(1) SOP-8L



<u>section a - a</u>

⊕ ⊕ Ao = 6.50 Bo = 5.20 Ko = 2.10 K1 = 1.70





(2) SOP-8L-EP

